

CPC COOPERATIVE PATENT CLASSIFICATION

H ELECTRICITY

(NOTE omitted)

H01 BASIC ELECTRIC ELEMENTS

(NOTE omitted)

H01G CAPACITORS; CAPACITORS, RECTIFIERS, DETECTORS, SWITCHING DEVICES OR LIGHT-SENSITIVE DEVICES, OF THE ELECTROLYTIC TYPE (selection of specified materials as dielectric [H01B 3/00](#); {ceramics [C04B](#)})

WARNING

In this subclass non-limiting references (in the sense of paragraph 39 of the Guide to the IPC) may still be displayed in the scheme.

2/00	Details of capacitors not covered by a single one of groups H01G 4/00-H01G 11/00	4/105	{Glass dielectric}
		4/12	Ceramic dielectrics {(H01G 4/085 takes precedence; ceramic materials per se C04B 35/00)}
2/02	. Mountings			
2/04	. . specially adapted for mounting on a chassis			
2/06	. . specially adapted for mounting on a printed-circuit support	4/1209	{characterised by the ceramic dielectric material (H01G 4/1272, H01G 4/1281 take precedence)}
2/065	. . . {for surface mounting, e.g. chip capacitors}			
2/08	. Cooling arrangements; Heating arrangements; Ventilating arrangements	4/1218	{based on titanium oxides or titanates (H01G 4/1245 takes precedence)}
2/10	. Housing; Encapsulation	4/1227	{based on alkaline earth titanates}
	<u>WARNING</u>	4/1236	{based on zirconium oxides or zirconates (H01G 4/1263 takes precedence)}
	Not complete, see also H01G 4/224			
2/103	. . {Sealings, e.g. for lead-in wires; Covers}	4/1245	{containing also titanates}
2/106	. . {Fixing the capacitor in a housing}	4/1254	{based on niobium or tungsten, tantalum oxides or niobates, tantalates}
2/12	. Protection against corrosion (H01G 2/10 takes precedence)	4/1263	{containing also zirconium oxides or zirconates}
2/14	. Protection against electric or thermal overload (by cooling H01G 2/08)	4/1272	{Semiconductive ceramic capacitors}
2/16	. . with fusing elements	4/1281	{with grain boundary layer}
2/18	. . with breakable contacts	4/129	{containing a glassy phase, e.g. glass ceramic}
2/20	. Arrangements for preventing discharge from edges of electrodes	4/14	Organic dielectrics
2/22	. Electrostatic or magnetic shielding	4/145	{vapour deposited}
2/24	. Distinguishing marks, e.g. colour coding	4/16	of fibrous material, e.g. paper
4/00	Fixed capacitors; Processes of their manufacture (electrolytic capacitors H01G 9/00)	4/18	of synthetic material, e.g. derivatives of cellulose (H01G 4/16 takes precedence)
4/002	. Details	4/183	{Derivatives of cellulose (H01G 4/145 takes precedence)}
4/005	. . Electrodes	4/186	{halogenated (H01G 4/145 takes precedence)}
4/008	. . . Selection of materials	4/20	using combinations of dielectrics from more than one of groups H01G 4/02 - H01G 4/06 (H01G 4/12 takes precedence)
4/0085 {Fried electrodes}	4/203	{Fibrous material or synthetic material}
4/01	. . . Form of self-supporting electrodes	4/206	{inorganic and synthetic material}
4/012	. . . Form of non-self-supporting electrodes	4/22	impregnated
4/015	. . . Special provisions for self-healing	4/221	{characterised by the composition of the impregnant}
4/018	. . Dielectrics	4/222	{halogenated}
4/02	. . . Gas or vapour dielectrics	4/224	Housing; Encapsulation
4/04	. . . Liquid dielectrics	4/228	Terminals
4/06	. . . Solid dielectrics			
4/08 Inorganic dielectrics			
4/085 {Vapour deposited}			
4/10 Metal-oxide dielectrics {(H01G 4/085 takes precedence)}			

4/232	. . . electrically connecting two or more layers of a stacked or rolled capacitor	5/10	. . . due to rotation of helical electrodes
4/2325 {characterised by the material of the terminals}	5/12	. . . due to rotation of part-cylindrical, conical, or spherical electrodes
4/236	. . . leading through the housing, i.e. lead-through	5/14	. . . due to longitudinal movement of electrodes
4/242	. . . the capacitive element surrounding the terminal	5/145	. . . {with profiled electrodes}
4/245 Tabs between the layers of a rolled electrode	5/16	. . . using variation of distance between electrodes
4/248	. . . the terminals embracing or surrounding the capacitive element, e.g. caps (H01G 4/252 takes precedence)	5/18	. . . due to change in inclination, e.g. by flexing, by spiral wrapping
4/252	. . . the terminals being coated on the capacitive element (H01G 4/232 takes precedence)	5/38	. . . Multiple capacitors, e.g. ganged
4/255	. . Means for correcting the capacitance value	5/40	. . Structural combinations of variable capacitors with other electric elements not covered by this subclass, the structure mainly consisting of a capacitor, e.g. RC combinations (RC-filters H03H)
4/258	. . Temperature compensation means	7/00	Capacitors in which the capacitance is varied by non-mechanical means; Processes of their manufacture (capacitors with potential jump or surface barrier H01L 29/00)
4/26	. . Folded capacitors	7/02	. . Electrets, i.e. having a permanently-polarised dielectric
4/28	. . Tubular capacitors	7/021	. . . {having an organic dielectric}
4/30	. . Stacked capacitors (H01G 4/33 takes precedence)	7/023 {of macromolecular compounds}
4/302	. . . {obtained by injection of metal in cavities formed in a ceramic body}	7/025	. . . {having an inorganic dielectric}
4/304	. . . {obtained from another capacitor}	7/026 {with ceramic dielectric}
4/306	. . . {made by thin film techniques}	7/028	. . . {having a heterogeneous dielectric}
4/308	. . . {made by transfer techniques}	7/04	. . having a dielectric selected for the variation of its permittivity with applied temperature
4/32	. . Wound capacitors	7/06	. . having a dielectric selected for the variation of its permittivity with applied voltage, i.e. ferroelectric capacitors (electrets H01G 7/02)
4/33	. . Thin- or thick-film capacitors (thin- or thick-film circuits H01L 27/00 {capacitors without a potential-jump or surface barrier specially adapted for integrated circuits, details thereof, multistep manufacturing processes therefor H01L 28/40 })	9/00	Electrolytic capacitors, rectifiers, detectors, switching devices, light-sensitive or temperature-sensitive devices; Processes of their manufacture
4/35	. . Feed-through capacitors or anti-noise capacitors	9/0003	. . {Protection against electric or thermal overload; cooling arrangements; means for avoiding the formation of cathode films (H01G 9/12 takes precedence)}
4/38	. . Multiple capacitors, i.e. structural combinations of fixed capacitors	2009/0007	. . {Double layer capacitors}
4/385	. . . {Single unit multiple capacitors, e.g. dual capacitor in one coil}	2009/001	. . {Temperature sensitive devices}
4/40	. . Structural combinations of fixed capacitors with other electric elements, the structure mainly consisting of a capacitor, e.g. RC combinations (thin or thick film circuits H01L 27/00 ; {capacitors without a potential-jump or surface barrier specially adapted for integrated circuits, details thereof, multistep manufacturing processes therefor H01L 28/40 })	2009/0014	. . {Solid electrolytic capacitors}
5/00	Capacitors in which the capacitance is varied by mechanical means, e.g. by turning a shaft; Processes of their manufacture	2009/0018	. . . {with wound foil electrodes}
5/01	. . Details	2009/0021	. . . {Skin fibre}
5/011	. . Electrodes	2009/0025	. . {Liquid electrolytic capacitors}
5/012	. . . at least one of the electrodes being a displaceable liquid or powder	9/0029	. . {Processes of manufacture}
5/013	. . Dielectrics	9/0032	. . . {formation of the dielectric layer (anodisation in general C25D)}
5/0132 {Liquid dielectrics}	9/0036	. . . {Formation of the solid electrolyte layer}
5/0134 {Solid dielectrics}	9/004	. . Details
5/0136 {with movable electrodes}	9/008	. . Terminals
5/0138 {with movable dielectrics}	9/012	. . . specially adapted for solid capacitors
5/014	. . Housing; Encapsulation	9/016 {specially adapted for double-layer capacitors}
5/015	. . Current collectors	9/02	. . Diaphragms; Separators
5/017	. . Temperature compensation	9/022	. . Electrolytes, absorbents (electrolytic or electrophoretic processes, apparatus therefor C25 ; for primary, secondary or fuel cells H01M)
5/019	. . Means for correcting the capacitance characteristics	9/025	. . . Solid electrolytes (H01G 11/54 takes precedence)
2005/02	. . {IPC5 having air, gas, or vacuum as the dielectric}	9/028 Organic semiconducting electrolytes, e.g. TCNQ
5/04	. . using variation of effective area of electrode	9/032 Inorganic semiconducting electrolytes, e.g. MnO ₂
5/06	. . due to rotation of flat or substantially flat electrodes	9/035	. . . Liquid electrolytes, e.g. impregnating materials (H01G 11/54 takes precedence)
5/08	. . . becoming active in succession		

- 9/038 . . . {Electrolytes specially adapted for double-layer capacitors}
- WARNING**
- This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to group [H01G 11/54](#)
- 9/04 . . Electrodes {or formation of dielectric layers thereon}
- 2009/0404 . . . {characterised by the material (alloys in general see [C22C](#))}
- 2009/0408 {on Al basis}
- 2009/0412 . . . {characterised by the structure}
- 2009/0416 {Etched foil electrodes (etching of metal in general [C23F](#); electro-etching of metal in general [C25F](#))}
- 9/042 . . . characterised by the material ([H01G 11/22](#) takes precedence)
- 9/0425 {specially adapted for cathode}
- 9/045 based on aluminium
- 9/048 . . . characterised by their structure ([H01G 11/22](#) takes precedence)
- 2009/05 {consisting of tantalum, niobium, or sintered material; Combinations of such electrodes with solid semiconductive electrolytes, e.g. manganese dioxide}
- 9/052 Sintered electrodes
- 9/0525 {Powder therefor (metallic powder in general [B22F](#))}
- 9/055 Etched foil electrodes
- 9/058 . . . {specially adapted for double-layer capacitors}
- WARNING**
- This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to group [H01G 11/22](#)
- 9/06 . . . Mounting in containers
- WARNING**
- This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to groups [H01G 11/66](#) - [H01G 11/74](#)
- 9/07 . . Dielectric layers
- 9/08 . . Housing; Encapsulation
- 9/10 . . . Sealing, e.g. of lead-in wires
- 9/12 . . . Vents or other means allowing expansion
- 9/14 . . Structural combinations {or circuits} for modifying, or compensating for, electric characteristics of electrolytic capacitors ([impedance networks \[H03H\]\(#\)](#))
- 9/145 . Liquid electrolytic capacitors ([H01G 11/00](#) takes precedence)
- 9/15 . Solid electrolytic capacitors ([H01G 11/00](#) takes precedence)
- 9/151 . . {with wound foil electrodes}
- 9/153 . . {Skin fibre}
- 9/155 . {Double-layer capacitors}
- WARNING**
- This group is no longer used for classification of new documents as from October 1, 2012. The backfile is being continuously reclassified to group [H01G 11/00](#) and its subgroups
- 9/16 . specially for use as rectifiers or detectors ([H01G 9/22](#) takes precedence)
- 9/18 . Self-interrupters
- 9/20 . Light-sensitive devices
- 9/2004 . . . {characterised by the electrolyte, e.g. comprising an organic electrolyte}
- 9/2009 . . . {Solid electrolytes}
- 9/2013 . . . {the electrolyte comprising ionic liquids, e.g. alkyl imidazolium iodide}
- 9/2018 . . . {characterised by the ionic charge transport species, e.g. redox shuttles}
- 9/2022 . . {characterized by he counter electrode}
- 9/2027 . . {comprising an oxide semiconductor electrode}
- 9/2031 . . . {comprising titanium oxide, e.g. TiO₂ ([H01G 9/2036](#) takes precedence)}
- 9/2036 . . . {comprising mixed oxides, e.g. ZnO covered TiO₂ particles}
- 9/204 . . . {comprising zinc oxides, e.g. ZnO ([H01G 9/2036](#) takes precedence)}
- 9/2045 . . {comprising a semiconductor electrode comprising elements of the fourth group of the Periodic System (C, Si, Ge, Sn, Pb) with or without impurities, e.g. doping materials}
- 9/205 . . {comprising a semiconductor electrode comprising AIII-BV compounds with or without impurities, e.g. doping materials}
- 9/2054 . . {comprising a semiconductor electrode comprising AII-BVI compounds, e.g. CdTe, CdSe, ZnTe, ZnSe, with or without impurities, e.g. doping materials ([H01G 9/2027](#) takes precedence)}
- 9/2059 . . {comprising an organic dye as the active light absorbing material, e.g. adsorbed on an electrode or dissolved in solution}
- 9/2063 . . . {comprising a mixture of two or more dyes}
- 9/2068 . . {Panels or arrays of photoelectrochemical cells, e.g. photovoltaic modules based on photoelectrochemical cells}
- 9/2072 . . . {comprising two or more photoelectrodes sensible to different parts of the solar spectrum, e.g. tandem cells}
- 9/2077 . . . {Sealing arrangements, e.g. to prevent the leakage of the electrolyte}
- 9/2081 . . . {Serial interconnection of cells}
- 9/2086 . . . {Photoelectrochemical cells in the form of a fiber}
- 9/209 . . {Light trapping arrangements}
- 9/2095 . . {comprising a flexible substrate}
- 9/21 . Temperature-sensitive devices
- 9/22 . Devices using combined reduction and oxidation, e.g. redox arrangement or solion
- 9/26 . Structural combinations of electrolytic capacitors, rectifiers, detectors, switching devices, light-sensitive or temperature-sensitive devices with each other

H01G

- 9/28 . Structural combinations of electrolytic capacitors, rectifiers, detectors, switching devices with other electric components not covered by this subclass
- 11/00 Hybrid capacitors, i.e. capacitors having different positive and negative electrodes; Electric double-layer [EDL] capacitors [EDLCs]; Processes specially adapted for the manufacture thereof or of parts thereof**
- NOTE**
- Group [H01G 11/02](#) takes precedence over groups [H01G 11/04](#) - [H01G 11/14](#)
- WARNING**
- Groups [H01G 11/00](#) - [H01G 11/86](#) are incomplete pending reclassification of documents from groups [H01M 12/00](#) and [H01M 12/005](#).
- All groups listed in this Warning should be considered in order to perform a complete search.
- 11/02 . using combined reduction-oxidation reactions, e.g. redox arrangement or solion
- 11/04 . Hybrid capacitors
- 11/06 . . with one of the electrodes allowing ions or anions to be reversibly doped thereinto, e.g. lithium-ion capacitors [LICs]
- 11/08 . Structural combinations, e.g. assembly or connection, of hybrid or EDL capacitors with other electric components, at least one hybrid or EDL capacitor being the main component
- 11/10 . Multiple hybrid or EDL capacitors, e.g. arrays or modules ([housings, cases or mountings thereof H01G 11/78](#))
- 11/12 . . Stacked hybrid or EDL capacitors
- 11/14 . Arrangements or processes for adjusting or protecting hybrid or EDL capacitors ([emergency protective circuit arrangements specially adapted for capacitors, and effecting automatic switching in the event of an undesired change from normal working conditions H02H 7/16; emergency protective circuit arrangements for limiting excess current or voltages without disconnection H02H 9/00](#))
- 11/16 . . against electric overloads, e.g. including fuses
- 11/18 . . against thermal overloads, e.g. heating, cooling or ventilating
- 11/20 . . Reformation or processes for removal of impurities, e.g. scavenging
- 11/22 . Electrodes
- 11/24 . . characterised by structural features, e.g. forms, shapes, surface areas, porosities or dimensions, of the materials making up or comprised in the electrodes; characterised by the structural features of powders or particles used therefor
- 11/26 . . characterised by the structures of the electrodes, e.g. multi-layered, shapes, dimensions, porosities or surface features
- 11/28 . . . arranged or disposed on a current collector; Layers or phases between electrodes and current collectors, e.g. adhesives
- 11/30 . . characterised by their materials
- 11/32 . . . Carbon-based, e.g. activated carbon materials
- 11/34 characterised by carbonisation or activation of carbon
- 11/36 Nanostructures, e.g. nanofibres, nanotubes or fullerenes
- 11/38 Carbon pastes or blends; Binders or additives therein
- 11/40 Fibres
- 11/42 Powders or particles, e.g. composition thereof
- 11/44 Raw materials therefor, e.g. resins or coal
- 11/46 . . . Metal oxides, e.g. ruthenium oxide
- 11/48 . . . Conductive polymers
- 11/50 . . . specially adapted for lithium-ion capacitors, e.g. for lithium-doping or for intercalation
- 11/52 . Separators
- 11/54 . Electrolytes
- 11/56 . . Solid electrolytes, e.g. gels; Additives therein
- 11/58 . . Liquid electrolytes
- 11/60 . . . characterised by the solvent
- 11/62 . . . characterised by the solute, e.g. salts, anions or cations therein
- 11/64 . . . characterised by additives
- 11/66 . Current collectors
- 11/68 . . characterised by their materials
- 11/70 . . characterised by their structures
- 11/72 . . specially adapted for integration in multiple or stacked hybrid or EDL capacitors
- 11/74 . Terminals, e.g. extensions of current collectors
- 11/76 . . specially adapted for integration in multiple or stacked hybrid or EDL capacitors
- 11/78 . Cases; Housings; Encapsulations; Mountings
- 11/80 . . Gaskets; Sealings
- 11/82 . . Fixing or assembling a capacitive element in a housing, e.g. mounting electrodes, current collectors or terminals in containers or encapsulations
- 11/84 . Processes for the manufacture of hybrid or EDL capacitors, or components thereof
- 11/86 . . specially adapted for electrodes ([carbonisation or activation of carbon for the manufacture of electrodes H01G 11/34](#))
- 13/00 Apparatus specially adapted for manufacturing capacitors; Processes specially adapted for manufacturing capacitors not provided for in groups [H01G 4/00](#) - [H01G 11/00](#)**
- 13/003 . {Apparatus or processes for encapsulating capacitors}
- 13/006 . {Apparatus or processes for applying terminals}
- 13/02 . Machines for winding capacitors ([winding in general B65H](#))
- 13/04 . Drying ([in general F26B](#)); Impregnating
- 13/06 . with provision for removing metal surfaces
- 15/00 Structural combinations of capacitors or other devices covered by at least two different main groups of this subclass with each other ([involving at least one hybrid or electric double-layer \[EDL\] capacitor as main component H01G 11/08](#))**
- 17/00 Structural combinations of capacitors or other devices covered by at least two different main groups of this subclass with other electric elements, not covered by this subclass, e.g. RC combinations ([thin- or thick-film circuits H01L 27/00; RC-filters H03H](#))**